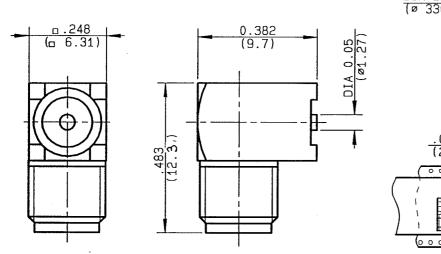
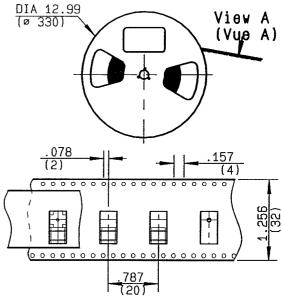
RIGHT ANGLE JACK RECEPTACLE FOR PCB SOLDER LEGS

R124.681.800

Series : **SMA-COM**





All dimensions are in mm.

COMPONENTS	MATERIALS	PLATINGS (μm)	
BODY CENTER CONTACT OUTER CONTACT INSULATOR GASKET OTHERS PARTS -	BRASS BERYLLIUM COPPER - PTFE	GOLD 0.2 OVER NICKEL 2 GOLD 0.5 OVER NICKEL 2	

Issue: 0430 B

In the effort to improve our products, we reserve the right to make changes judged to be necessary.



RIGHT ANGLE JACK RECEPTACLE FOR PCB **SOLDER LEGS**

5000 M Ω mini

R124.681.800

Series: **SMA-COM**

PACKAGING

Standard Unit Other 100 'W' option **Contact us**

SPECIFICATION

ELECTRICAL CHARACTERISTICS

Impedance 50 Ω **0-6** GHz

Frequency **VSWR 0.000** x F(GHz) Maxi **1.16** +

Insertion loss **0.07** $\sqrt{F(GHz)}$ dB Maxi **60** - F(GHz)) dB Maxi

RF leakage - (Voltage rating 500 Veff Maxi Dielectric withstanding voltage 1000 Veff mini Insulation resistance

ENVIRONMENTAL

-65/+165 ° C Operating temperature Hermetic seal NA Atm.cm3/s

Panel leakage NA

OTHERS CHARACTERISTICS

Assembly instruction

Others:

MECHANICAL CHARACTERISTICS

Center contact retention

Axial force – Mating end 15 N mini Axial force – Opposite end 15 N mini Torque 1 N.cm mini

Recommended torque

Mating **40** N.cm Panel nut NA N.cm

Mating life 100 Cycles mini

Weight **3.000** g

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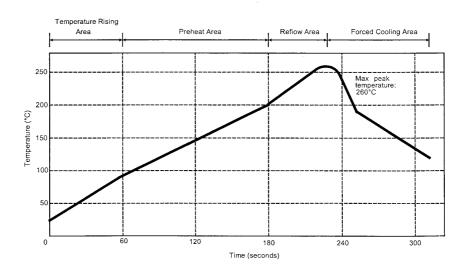
Series: SMA-COM

SOLDER PROCEDURE

- 1. Deposition of solder paste 'Sn Ag4 Cu0.5' on mounting zone by screen printing application. We recommend a low residue flux.
 - We advise a thickness of 150 microns (5.850 microinch). Verify that the edges of the zone are clean.
- 2. Placement of the receptacle on the mounting zone with an automatic machine of 'pick and place' type. Aspiration port (see page 4) centered into body and push against it.

 Video compare is recommended for the positioning of the component. Adhesive agents must not be used.
 - Video camera is recommended for the positioning of the component. Adhesive agents must not be used on the receptacle.
- 3. Soldering by infra-red reflow. Below, please find the typical profile to use.
- 4. Cleaning of printed circuit boards by CFC solvents (or a substitute product according to united nation's environmental program.)
- 5. Checking of solder joints and position of the component by visual inspection.

TEMPERATURE PROFILE



Parameter	Value	Unit
Temperature rising Area	1 - 4	°C/sec
Max Peak Temperature	260	°C
Max dwell time @260°C	10	sec
Min dwell time @235°C	20	sec
Max dwell time @235°C	60	sec
Temperature drop in cooling Area	-1 to -4	°C/sec
Max dwell time above 100°C	420	sec

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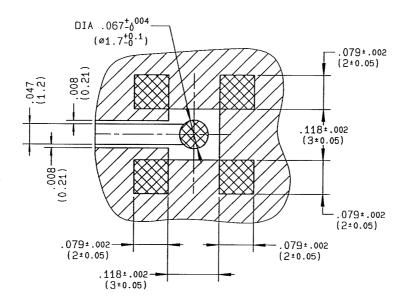


RIGHT ANGLE JACK RECEPTACLE FOR PCB SOLDER LEGS

R124.681.800

Series: SMA-COM

SMA B SERIES - INFORMATIONS



COPLANAR LINE

Pattern and signal are on the same side Thickness of PCB: .063 (1.6 mm) The material of PCB is the epoxy resin of glass fabrics bacs.(Er = 4.8) The solder resist should be printed exept for the land pattern on the PCB.

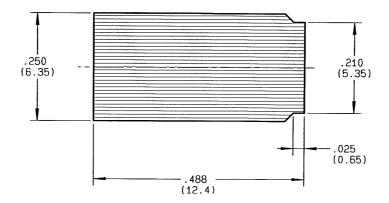


Pattern



Land for solder paste

SHADOW OF 'SMA B' RECEPTACLE FOR VIDEO CAMERA



Issue: 0430 B
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